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ON Semiconductor®

# FDD86569-F085

# N-Channel PowerTrench<sup>®</sup> MOSFET 60 V, 90 A, 5.7 m $\Omega$

#### **Features**

- Typical  $R_{DS(on)}$  = 4.2  $m\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 80 A
- Typical  $Q_{g(tot)}$  = 35 nC at  $V_{GS}$  = 10V,  $I_D$  = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

#### **Applications**

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems



Symbol	rameter	Ratings	Units
$V_{DSS}$	Drain-to-Sr , ce Voltage	60	V
$V_{GS}$	Gate-to-Sc ce Volta 3	±20	V
1	r uin currei Con⁴ uous (V <sub>GS</sub> = (2) (Note 1) T <sub>C</sub> = 25°C	90	A
ID	n Current 7 <sub>C</sub> = 25°C	See Figure 4	_ ^
FAG	Single Pi : Avalanche E nergy (Note 2)	41	mJ
ID T	'owe, Dissipation	150	W
$P_D$	L _rate Abo re 25,0C	1.0	W/°C
T <sub>J</sub> , T <sub>G</sub>	Operating and Storage Temperature	-55 to + 175	°C
, ic	Thermal Resistance, Junction to Case	1.0	°C/W
$R_{\theta J \Lambda}$	Maximum 1 Fermal Resistance, Junction to Ambient (Note 3)	52	°C/W

#### Notes:

- 1: Current is limited by 50 no vire configuration.
- 2: Starting T<sub>J</sub> = 25°C, L = ¬□µH, I<sub>AS</sub> = 74A, V<sub>DD</sub> = 60V during inductor charging and V<sub>DD</sub> = 0V during time in avalanche.

  3: R<sub>θ,JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder
- 3: R<sub>θJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>θJC</sub> is guaranteed by design, while R<sub>θJA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86569	FDD86569-F085	D-PAK(TO-252)	13"	16mm	2500units

Units

Max.

# **Electrical Characteristics** $T_J = 25$ °C unless otherwise noted.

**Parameter** 

Off Characteristics							
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	$I_D = 250 \mu A$	V <sub>GS</sub> = 0V	60	-	-	V
I <sub>DSS</sub>	Drain-to-Source Leakage Current	V <sub>DS</sub> =60V,	$T_J = 25^{\circ}C$	-	-	- 1 1	μΑ
	Diam-to-Source Leakage Current	$V_{GS} = 0V$	$T_J = 175^{\circ}C \text{ (Note 4)}$	-	-	1	mA
loco	Gate-to-Source Leakage Current	$V_{00} = +20$	1	_	_	+100	nA

**Test Conditions** 

Min.

Тур.

### On Characteristics

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , I	<sub>D</sub> = 250μA	2	2.5		V
D	Drain to Source On Resistance	I <sub>D</sub> = 80A,	$T_{\rm J} = 25^{\rm o}{\rm C}$	1	4.	5.,	$m\Omega$
R <sub>DS(on)</sub>	Dialit to Source Off Resistance	V <sub>GS</sub> = 10V	$T_J = 175^{\circ}C \text{ (Note 4)}$		8.3	11 '	mΩ

## **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	∠520 -	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, f = 1MHz	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	- 47 -	pF
$R_g$	Gate Resistance	V <sub>GS</sub> = 0.5V, -1N 7 - 2.0 -	Q
$Q_{g(ToT)}$	Total Gate Charge	$V_c$ ) to 10 = 30 $V_c$ - 35 52	nc.
Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS} = 2V$ $I_D = 85A$ - +3	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge	- 14	nC
$Q_{gd}$	Gate-to-Drain "Miller" Charge	0 - 70 -	nC

# **Switching Characteristic**

$t_{on}$	Turn-On Tir	-	-	53	ns
t <sub>d(on)</sub>	Turn-On f lay	-	15	-	ns
t <sub>r</sub>	$V_{DD} = 30 \text{ V, } I_D = 80 \text{A,}$	-	20	-	ns
t <sub>d(off)</sub>	urn-Off Del. $V_{33} = 10V, R_{GEN} = 6\Omega$	-	22	-	ns
t <sub>f</sub>	I TIME	-	8	-	ns
	Tu of time	-	-	45	ns

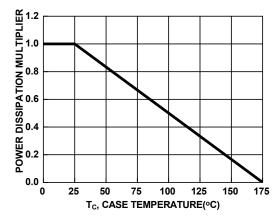
## Drai. So. ce Dicge Characterisacs

	-1/					
	Source-to-Prain Didue Voltage	$I_{SD} = 80A, V_{GS} = 0V$	-	1	1.25	٧
טכי	Scurse-to-12.4.1 Disde Voltage	$I_{SD}$ = 40A, $V_{GS}$ = 0V	-	1	1.2	٧
t <sub>r:</sub>	Reverse-Recovery Tirne	$V_{DD} = 48V, I_F = 80A,$	-	52	68	ns
$\mathcal{O}^{LL}$	Reverse-Recovery Charge	$dI_{SD}/dt = 100A/\mu s$	-	43	65	nC

#### Note:

4: The maximum value is specified by design at  $T_J$  = 175°C. Product is not tested to this condition in production.

## **Typical Characteristics**



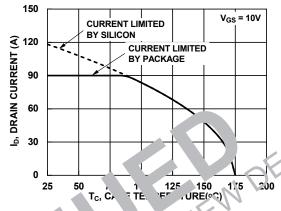


Figure 1. Normalized Power Dissipation vs. Case Temperature

Figure 2. axi. m Co tinuous Diain Current vs.

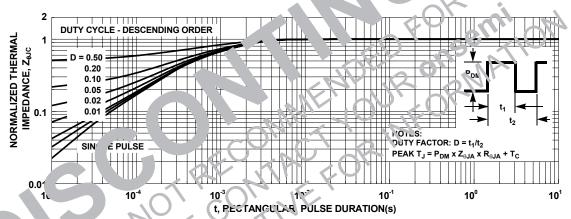


Figure 3. Normalized Maximum Transient Thermal Impedance

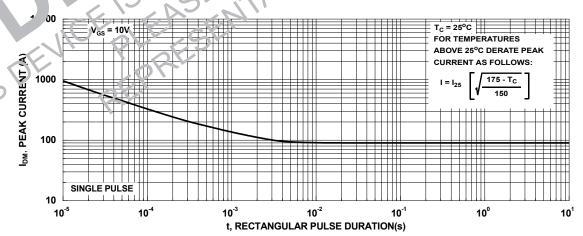


Figure 4. Peak Current Capability

## **Typical Characteristics**

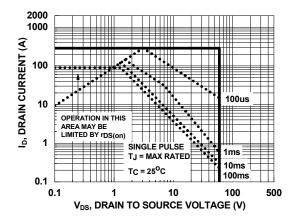
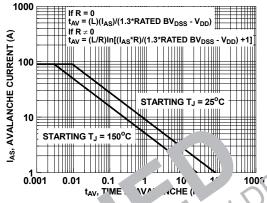
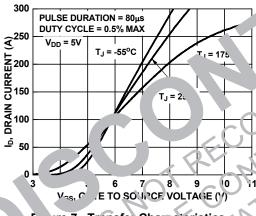


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to ON Sem. nduc Applir on Note: AN75  $\downarrow$  4 and AN7515

Figure Un 'ampe Inductive Switching Car Jility



F. vre 7. Transfer Characteristics

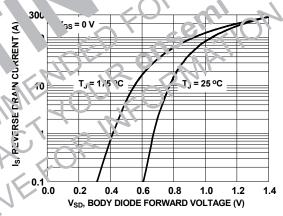


Figure 8. Forward Diode Characteristics

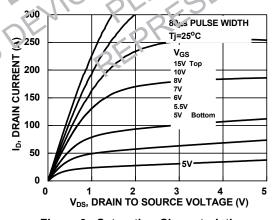


Figure 9. Saturation Characteristics

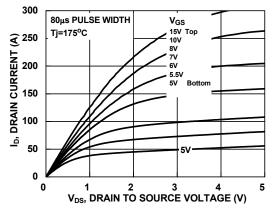


Figure 10. Saturation Characteristics

## **Typical Characteristics**

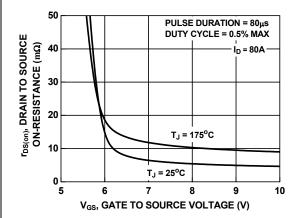


Figure 11. R<sub>DSON</sub> vs. Gate Voltage

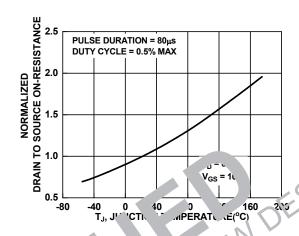
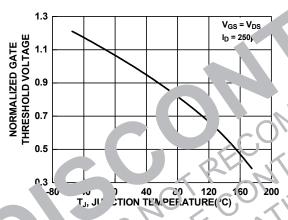


Figure 12 Norma rea SON vs. Junction Ten grature



Figu 15 lormalized Gate Threshold Voltage vs.

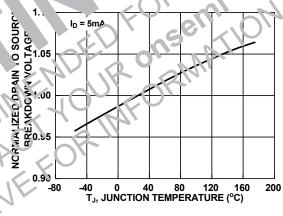


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

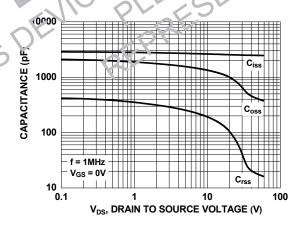


Figure 15. Capacitance vs. Drain to Source Voltage

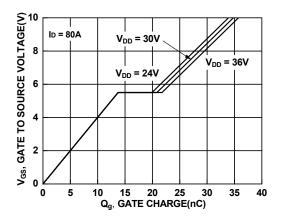


Figure 16. Gate Charge vs. Gate to Source Voltage



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